

UNITED STATES PATENT AND TRADEMARK OFFICE  
**CERTIFICATE OF CORRECTION**

PATENT NO. : 6,838,375 B2  
DATED : January 4, 2005  
INVENTOR(S) : Hu

Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Column 1,

Line 5, after "This" delete "is".

Column 4,

Line 25, after "MSi<sub>x</sub>" delete "." and insert -- , --, therefor.

Column 5,

Line 23, after "228" delete "." and insert -- , --, therefor.

Line 24, after "MN<sub>y</sub>Si<sub>x</sub>" delete "." and insert -- , --, therefor.

Line 24, delete "0<x 2.5" and insert -- 0<x ≤2.5 --, therefor.

Column 8,

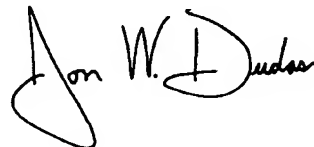
Line 27, delete "MoSi<sub>0.6</sub>" and insert -- WSi<sub>0.6</sub>--, therefor.

Column 15,

Line 50, after "forming" delete "an".

Signed and Sealed this

Ninth Day of August, 2005



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JON W. DUDAS  
*Director of the United States Patent and Trademark Office*